# 507182795 03/17/2022

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT7229641

	NEW ASSIGNMENT		
ANCE:	ASSIGNMENT	ASSIGNMENT	
DATA			
	Name	Execution Date	
SHAO HUA CHANG		02/16/2022	
		02/17/2022	
DATA EBARA (	CORPORATION		
EBARA (	CORPORATION NEDA ASAHI-CHO, OTA-KU		
EBARA (			
EBARA ( 11-1, HA			
	ANCE:	DATA Name	

Property Type	Number
Application Number:	17761304

# CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone:	2155683100
Email:	assignments@bakerlaw.com
Correspondent Name:	BAKERHOSTETLER
Address Line 1:	1735 MARKET STREET
Address Line 2:	SUITE 3300
Address Line 4:	PHILADELPHIA, PENNSYLVANIA 19103-7501

ATTORNEY DOCKET NUMBER:	101728.000285
NAME OF SUBMITTER:	ZHIMING DENG
SIGNATURE:	/Zhiming Deng/
DATE SIGNED:	03/17/2022
	This document serves as an Oath/Declaration (37 CFR 1.63).

# **Total Attachments: 4**

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PATENT REEL: 059293 FRAME: 0496

Docket No.:

#### COMBINED DECLARATION AND ASSIGNMENT

#### ASSIGNMENT

#### Assignor(s)

NAME Shao Hua CHANG
Address c/o Ebara Corporation of 11-1, Haneda Asahi-cho, Ota-ku, Tokyo 144-8510 Japan
NAME Masaya SEKI
Address c/o Ebara Corporation of 11-1, Haneda Asahi-cho, Ota-ku, Tokyo 144-8510 Japan

WHEREAS, ASSIGNOR(S) (listed above), are inventor(s) of one or more inventions disclosed, described and/or claimed in the application referred to as Docket Number ("the invention"), which is entitled

#### WETTING METHOD FOR SUBSTRATE AND PLATING APPARATUS

("the subject application"). I authorize and direct any of the attorneys responsible for prosecuting the subject application on behalf of the ASSIGNEE to insert the application number and filing date of the subject application in the final paragraph of this assignment.

AND WHEREAS, **EBARA CORPORATION**, ASSIGNEE, having a place of business at **11-1**, **Haneda Asahi-cho**, **Ota-ku**, **Tokyo 144-8510 Japan**, is desirous of obtaining my entire right, title, and interest in, to, and under the invention:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, ASSIGNOR(S), hereby sell, assign, transfer, and set over, unto the ASSIGNEE, its successors, legal representatives, and assigns, the entire right, title, and interest in, to, and under the invention, and all applications for industrial property protection, including without limitation, all applications for patents, utility models, inventors' certificates, and designs that have been filed, and that may hereafter be filed, in any country, that disclose, describe, and/or claim the invention, including, without limitation, the subject application and the priority application, and all extensions, renewals, and reissues of such applications, including all divisions and continuations in whole or in part; all patents granted on such applications in any country, and all extensions in any country the priority rights derived from the priority application and the subject applications in any country the priority rights derived from the priority application and the subject application under the International Convention for the Protection of Industrial Property, the Patent Laws of the United States, any other international agreement or

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### COMBINED DECLARATION AND ASSIGNMENT

protection, or the domestic laws of any country in which any such application is filed, as may be applicable.

AND ASSIGNOR(S) HEREBY covenant and agree that ASSIGNOR(S) have full right to convey the entire interest herein assigned, and that ASSIGNOR(S) have not executed, and will not execute, any agreement in conflict herewith.

AND ASSIGNOR(S) HEREBY further covenant and agree that ASSIGNOR(S) will communicate to the ASSIGNEE, its successors, legal representatives, and assigns, any facts known to ASSIGNOR(S) respecting the invention, and testify in any legal proceeding, sign all lawful papers, execute all disclaimers and all divisional, continuing, reissue, and foreign applications, make all rightful oaths, deliver upon request all papers, documents, affidavits, or other instruments that may be necessary or helpful in the prosecution of any application for industrial property protection describing and/or claiming the invention, and generally do everything possible to aid the ASSIGNEE, its successors, legal representatives, and assigns, to obtain and enforce proper protection for the invention in all countries.

Docket No.:

#### COMBINED DECLARATION AND ASSIGNMENT

#### DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76)

Title of Invention	WETTING METHOD FOR SUBSTRATE AND PLATING APPARATUS

As the below named inventor(s), I/we declare that:

This combined declaration and assignment is directed to:

the attached application, or

United States application or PCT international application number PCT/JP2020/049158 filed on December 28, 2020.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

**Notice to Inventor(s):** A person may not execute this declaration unless that person has reviewed and understands the contents of the above-identified application, including the claims.

**Notice to Inventor(s):** A person may not execute this declaration unless that person is aware of the duty to disclose to the US Patent and Trademark Office all information known to the person to be material to patentability as defined in 37 CFR 1.56.

Docket No.:

COMBINED DECLARATION AND ASSIGNMENT

Shao Hua CHANG Printed Name in English Sileso Hua CHANG Inventor's Signature 2022.02.16 Date

Masaya SEKI Printed Name in English <u>403-072</u> Sek Inventor's Signature 2032. 2. (7 Date

The foregoing Combined Declaration and Assignment covers patent application number 17/761,304, filed on March 17, 2022

/Michael J. Swope/ Name of Attorney: Registration No.: Date of Insertion:

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**RECORDED: 03/17/2022**